IXYS

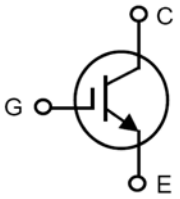
Preliminary Technical Information

XPT™ 650V IGBT GenX3™

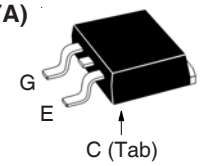
IXYA50N65C3
IXYP50N65C3
IXYH50N65C3

V_{CES} = 650V
I_{C110} = 50A
$V_{CE(sat)}$ ≤ 2.10V
$t_{fi(typ)}$ = 26ns

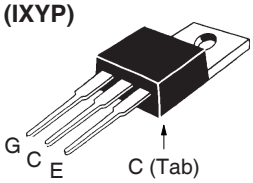
Extreme Light Punch Through
IGBT for 20-60kHz Switching



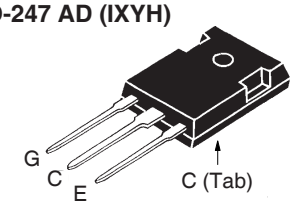
TO-263 (IXYA)



TO-220 (IXYP)



TO-247 AD (IXYH)



G = Gate C = Collector
E = Emitter Tab = Collector

Symbol	Test Conditions	Maximum Ratings	
V_{CES}	T_J = 25°C to 175°C	650	V
V_{CGR}	T_J = 25°C to 175°C, R_{GE} = 1MΩ	650	V
V_{GES}	Continuous	±20	V
V_{GEM}	Transient	±30	V
I_{C25}	T_C = 25°C	132	A
I_{C110}	T_C = 110°C	50	A
I_{CM}	T_C = 25°C, 1ms	250	A
I_A	T_C = 25°C	25	A
E_{AS}	T_C = 25°C	400	mJ
SSOA (RBSOA)	V_{GE} = 15V, T_{VJ} = 150°C, R_G = 5Ω Clamped Inductive Load	I_{CM} = 100 $V_{CE} \leq V_{CES}$	A
t_{sc} (SCSOA)	V_{GE} = 15V, V_{CE} = 360V, T_J = 150°C R_G = 82Ω, Non Repetitive	8	μs
P_C	T_C = 25°C	600	W
T_J		-55 ... +175	°C
T_{JM}		175	°C
T_{stg}		-55 ... +175	°C
T_L	Maximum Lead Temperature for Soldering	300	°C
T_{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C
F_C	Mounting Force (TO-263)	10..65 / 2.2..14.6	N/lb
M_d	Mounting Torque (TO-247 & TO-220)	1.13 / 10	Nm/lb.in
Weight	TO-263	2.5	g
	TO-220	3.0	g
	TO-247	6.0	g

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
BV_{CES}	I_C = 250μA, V_{GE} = 0V	650			V
$V_{GE(th)}$	I_C = 250μA, V_{CE} = V_{GE}	3.5		6.0	V
I_{CES}	V_{CE} = V_{CES}, V_{GE} = 0V			15	μA
	T_J = 150°C			250	μA
I_{GES}	V_{CE} = 0V, V_{GE} = ±20V			±100	nA
$V_{CE(sat)}$	I_C = 36A, V_{GE} = 15V, Note 1		1.73	2.10	V
	T_J = 150°C		2.10		V

Features

- Optimized for 20-60kHz Switching
- Square RBSOA
- Avalanche Rated
- Short Circuit Capability
- International Standard Packages

Advantages

- High Power Density
- Extremely Rugged
- Low Gate Drive Requirement

Applications

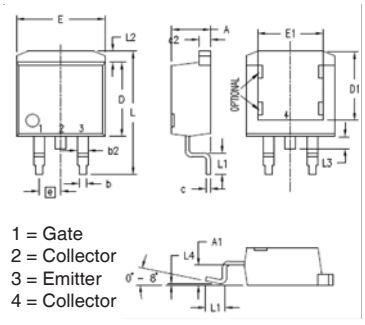
- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts
- High Frequency Power Inverters

Symbol	Test Conditions (T_J = 25°C Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	I_C = 36A, V_{CE} = 10V, Note 1	18	30		S
C_{ies}	V_{CE} = 25V, V_{GE} = 0V, f = 1MHz		2290		pF
C_{oes}			135		pF
C_{res}			50		pF
$Q_{g(on)}$	I_C = 36A, V_{GE} = 15V, V_{CE} = 0.5 • V_{CES}		86		nC
Q_{ge}			14		nC
Q_{gc}			40		nC
$t_{d(on)}$	**Inductive load, T_J = 25°C**		20		ns
t_{ri}	I_C = 36A, V_{GE} = 15V		36		ns
E_{on}	V_{CE} = 400V, R_G = 5Ω		0.80		mJ
$t_{d(off)}$	Note 2		90		ns
t_{fi}			26		ns
E_{off}			0.47	0.80	mJ
$t_{d(on)}$	**Inductive load, T_J = 150°C**		19		ns
t_{ri}	I_C = 36A, V_{GE} = 15V		37		ns
E_{on}	V_{CE} = 400V, R_G = 5Ω		1.60		mJ
$t_{d(off)}$	Note 2		113		ns
t_{fi}			32		ns
E_{off}			0.70		mJ
R_{thJC}				0.25	°C/W
R_{thCS}	TO-220		0.50		°C/W
R_{thCS}	TO-247		0.21		°C/W

Notes:

1. Pulse test, t ≤ 300µs, duty cycle, d ≤ 2%.
2. Switching times & energy losses may increase for higher V_{CE}(clamp), T_J or R_G.

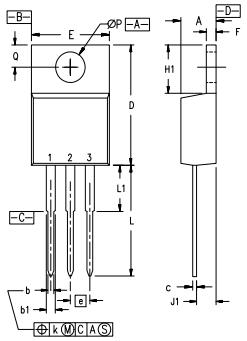
TO-263 Outline



1 = Gate
2 = Collector
3 = Emitter
4 = Collector

SYM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	.160	.190	4.06	4.83
A1	.080	.110	2.03	2.79
b	.020	.039	0.51	0.99
b2	.045	.055	1.14	1.40
c	.016	.029	0.40	0.74
c2	.045	.055	1.14	1.40
D	.340	.380	8.64	9.65
D1	.315	.350	8.00	8.89
E	.380	.410	9.65	10.41
E1	.245	.320	6.22	8.13
e	.100 BSC		2.54 BSC	
L	.575	.625	14.61	15.88
L1	.090	.110	2.29	2.79
L2	.040	.055	1.02	1.40
L3	.050	.070	1.27	1.78
L4	0	.005	0	0.13

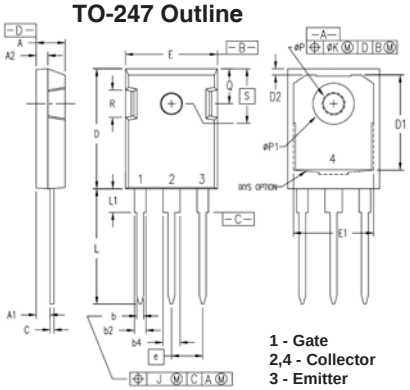
TO-220 Outline



Pins: 1 - Gate 2 - Collector
3 - Emitter

SYM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	.170	.190	4.32	4.83
b	.025	.040	0.64	1.02
b1	.045	.065	1.15	1.65
c	.014	.022	0.35	0.56
D	.580	.630	14.73	16.00
E	.390	.420	9.91	10.66
e	.100 BSC		2.54 BSC	
F	.045	.055	1.14	1.40
H1	.230	.270	5.85	6.85
J1	.090	.110	2.29	2.79
k	0	.015	0	0.38
L	.500	.550	12.70	13.97
L1	.110	.230	2.79	5.84
ØP	.139	.161	3.53	4.08
Q	.100	.125	2.54	3.18

TO-247 Outline



1 - Gate
2,4 - Collector
3 - Emitter

Dim.	Millimeter min	Millimeter max	Inches min	Inches max
A	4.70	5.30	0.185	0.209
A1	2.21	2.59	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	0.99	1.40	0.039	0.055
b2	1.65	2.39	0.065	0.094
b4	2.59	3.43	0.102	0.135
c	0.38	0.89	0.015	0.035
D	20.79	21.45	0.819	0.845
D1	13.07	-	0.515	-
D2	0.51	1.35	0.020	0.053
E	15.48	16.24	0.610	0.640
E1	13.45	-	0.53	-
E2	4.31	5.48	0.170	0.216
e	5.45 BSC		0.215 BSC	
L	19.80	20.30	0.078	0.800
L1	-	4.49	-	0.177
Ø P	3.55	3.65	0.140	0.144
Ø P1	-	7.39	-	0.290
Q	5.38	6.19	0.212	0.244
S	6.14 BSC		0.242 BSC	

PRELIMANARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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Fig. 1. Output Characteristics @ T_J = 25ºC

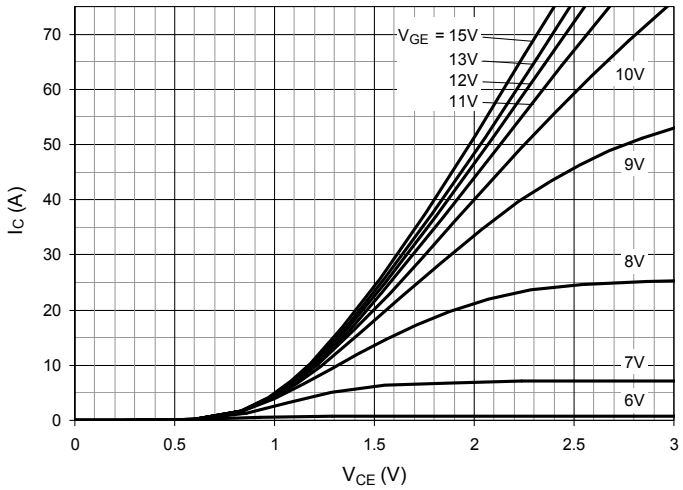

Fig. 2. Extended Output Characteristics @ T_J = 25ºC

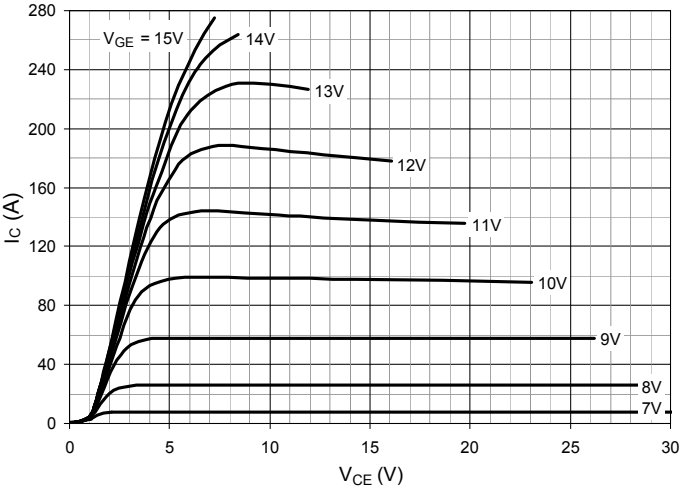

Fig. 3. Output Characteristics @ T_J = 150ºC

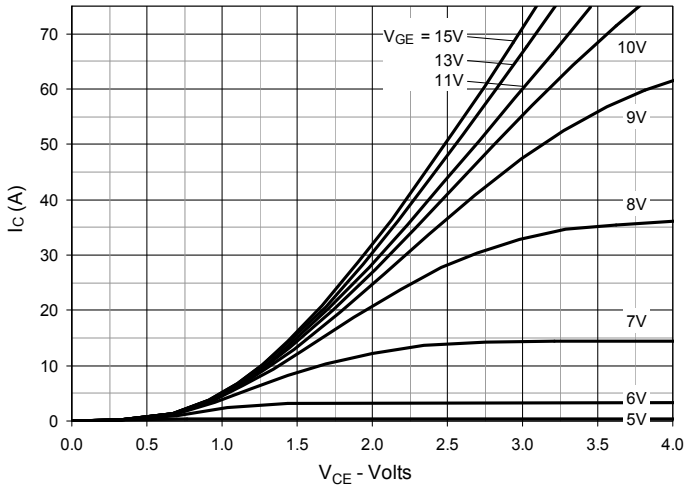

Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

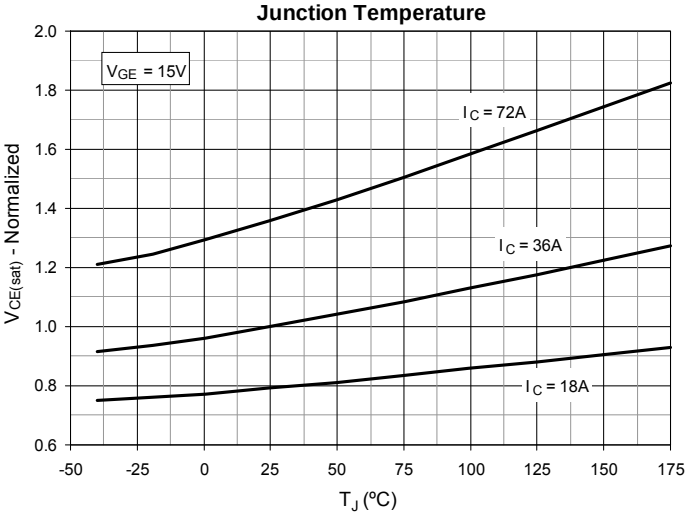

Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

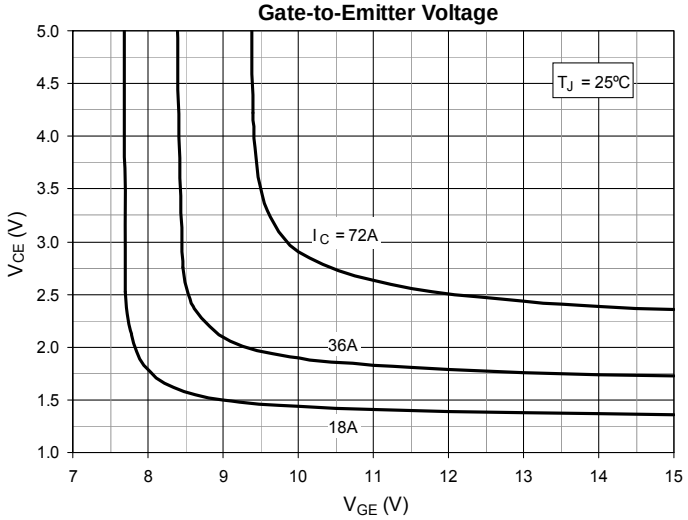

Fig. 6. Input Admittance

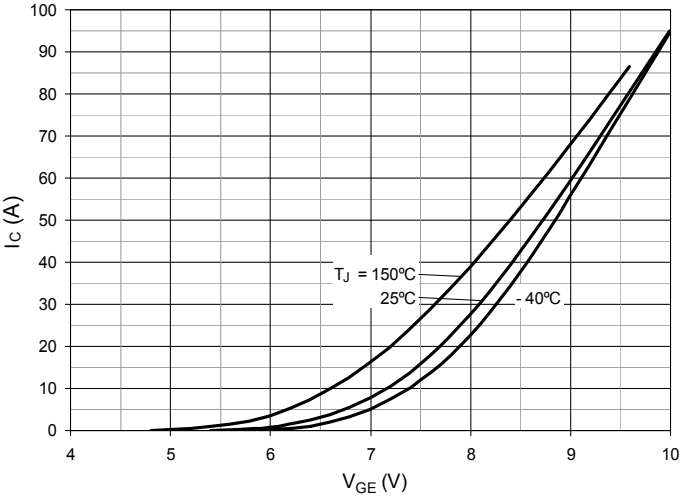

Fig. 7. Transconductance

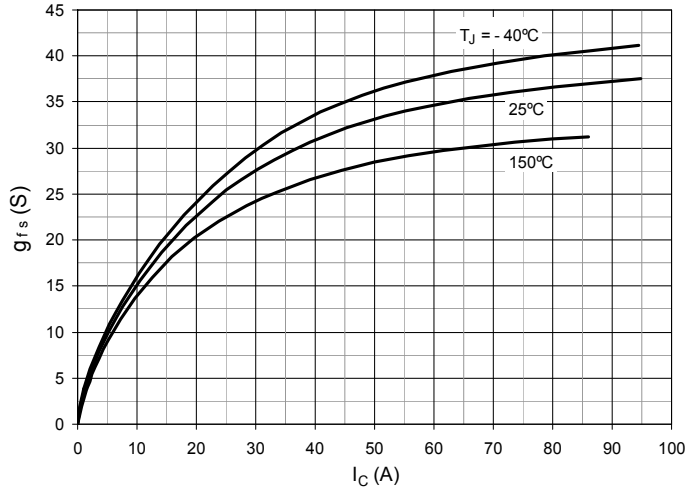

Fig. 8. Gate Charge

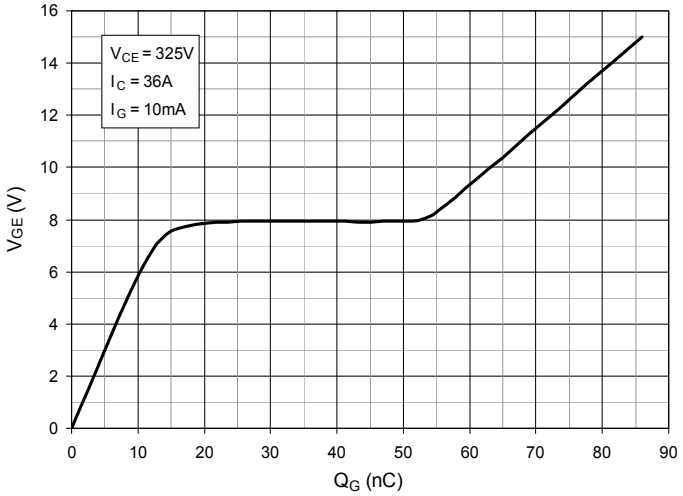

Fig. 9. Capacitance

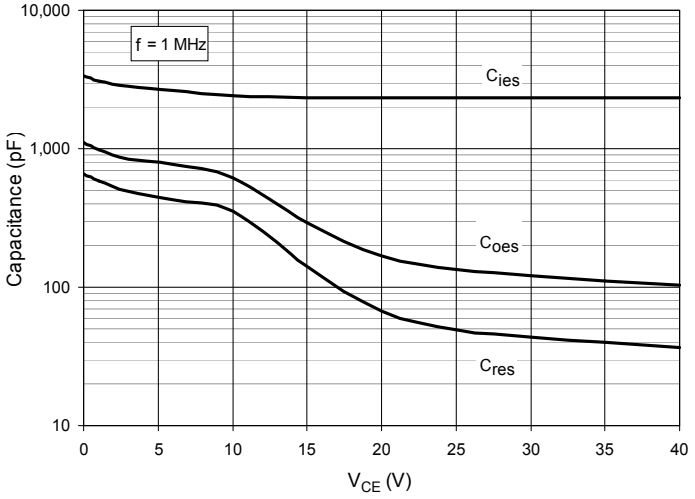

Fig. 10. Reverse-Bias Safe Operating Area

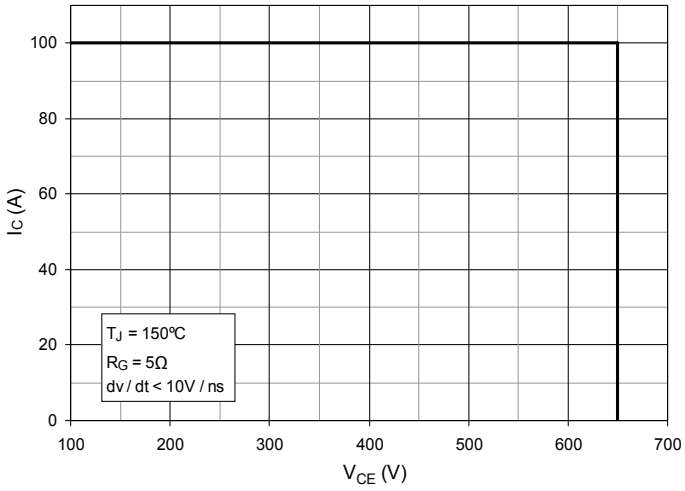

Fig. 11. Forward-Bias Safe Operating Area

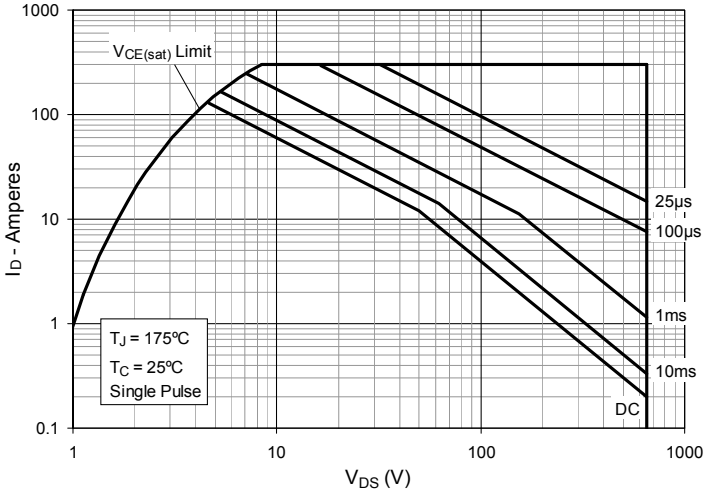

Fig. 12. Maximum Transient Thermal Impedance

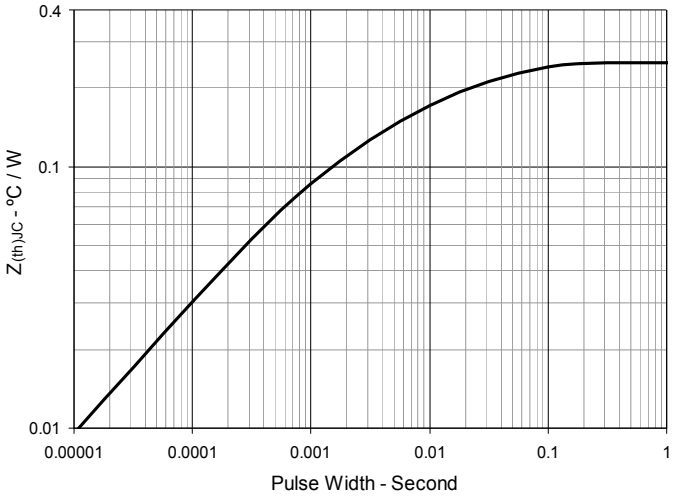

Fig. 13. Inductive Switching Energy Loss vs. Gate Resistance

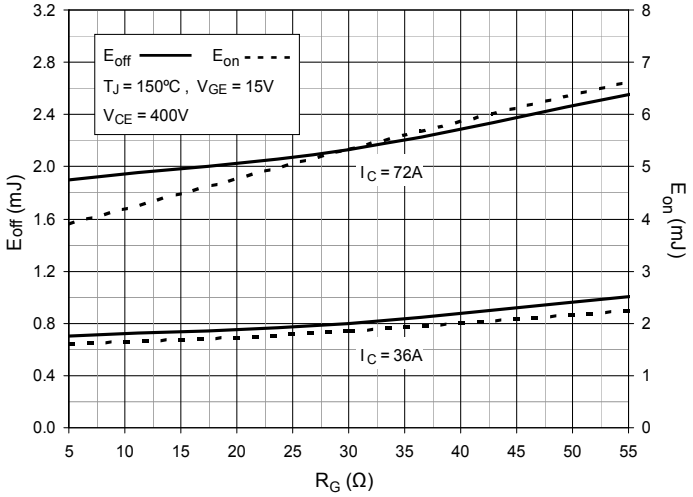

Fig. 14. Inductive Switching Energy Loss vs. Collector Current

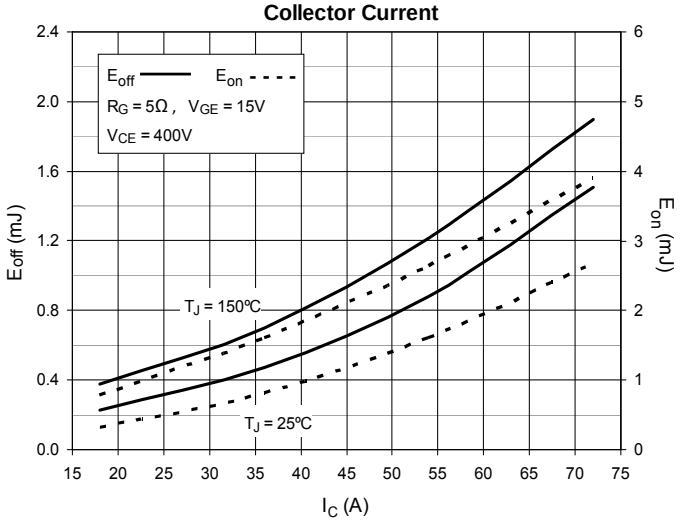

Fig. 15. Inductive Switching Energy Loss vs. Junction Temperature

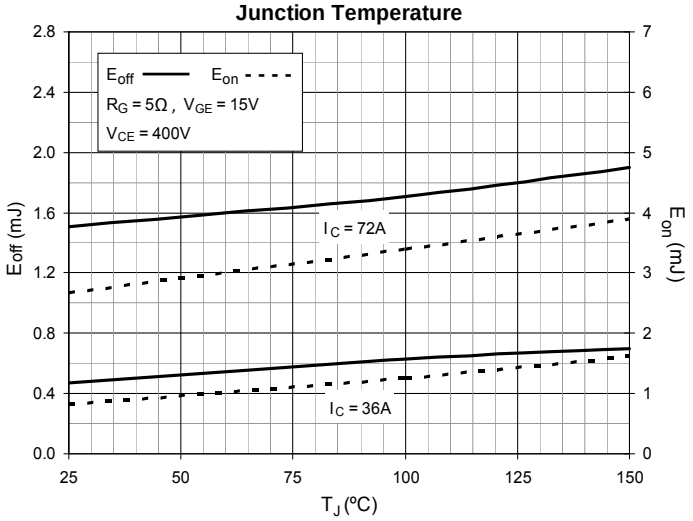

Fig. 16. Inductive Turn-off Switching Times vs. Gate Resistance

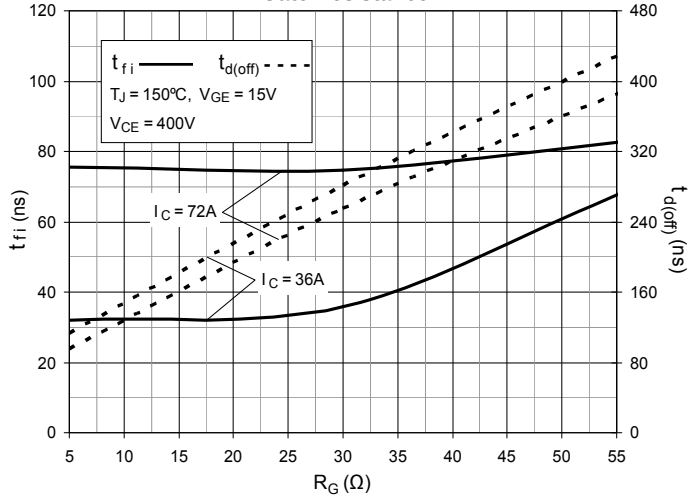

Fig. 17. Inductive Turn-off Switching Times vs. Collector Current

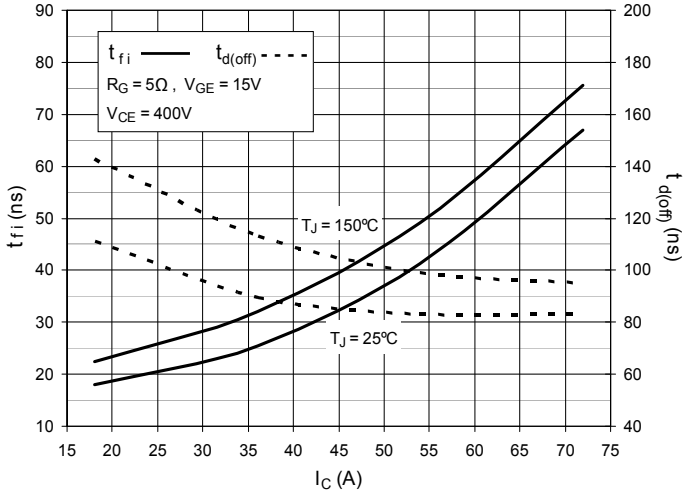

Fig. 18. Inductive Turn-off Switching Times vs. Junction Temperature

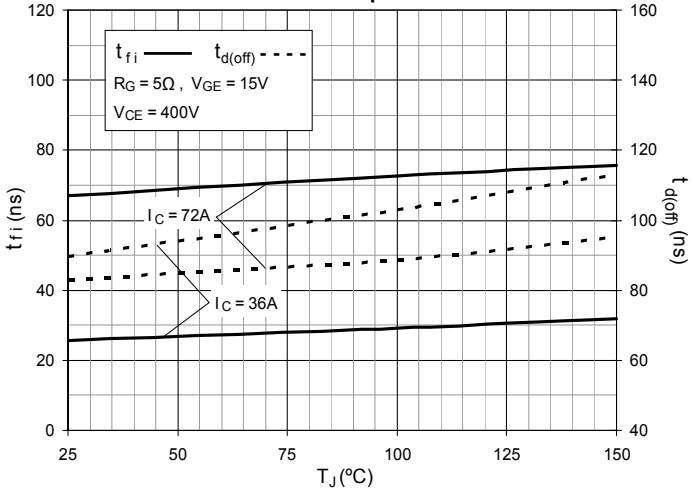

Fig. 19. Inductive Turn-on Switching Times vs. Gate Resistance

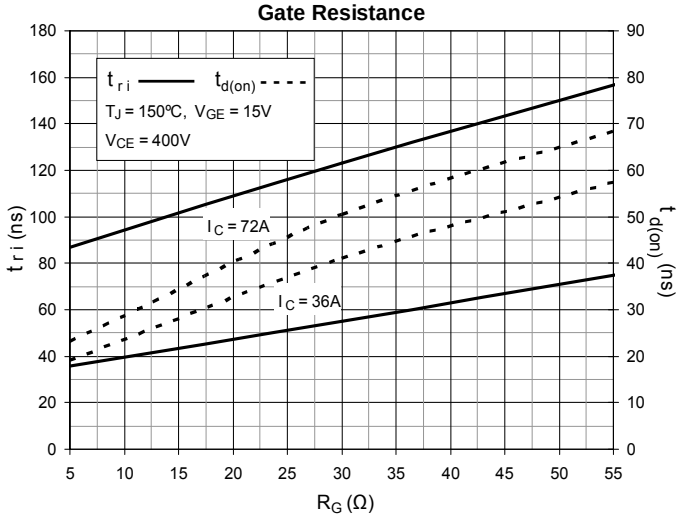

Fig. 20. Inductive Turn-on Switching Times vs. Collector Current

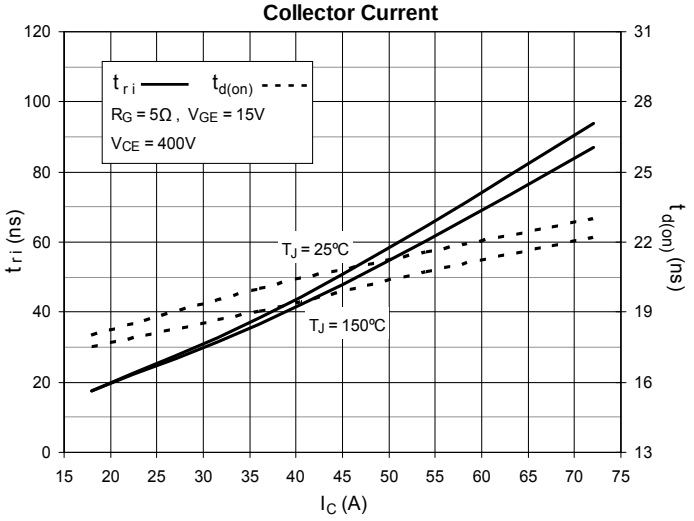

Fig. 21. Inductive Turn-on Switching Times vs. Junction Temperature

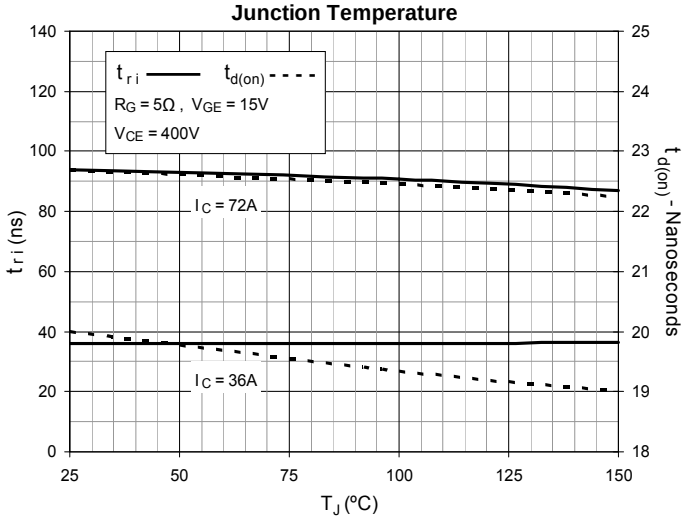

Fig. 22. Maximum Peak Load Current vs. Frequency